

K4207-VB Datasheet N-Channel 900V (D-S) Super Junction Power MOSFET

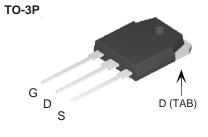
| PRODUCT SUMMARY | | | | |
|--|------------------------|------|--|--|
| V _{DS} (V) at T _J max. | 900 | 900 | | |
| R _{DS(on)} at 25 °C (Ω) | V _{GS} = 10 V | 0.75 | | |
| Q _g max. (nC) | 20 | 20 | | |
| Q _{gs} (nC) | 2.4 | | | |
| Q _{gd} (nC) | 11 | | | |
| Configuration | Single | | | |

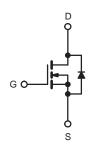
FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qq)
- Avalanche energy rated (UIS)

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial





N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | | |
|--|-------------------------|---|-----------------|-------|------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V_{DS} | 900 | | |
| Gate-Source Voltage | | | V_{GS} | ± 30 | V | |
| Continuous Drain Current (T _J = 150 °C) | V _{GS} at 10 V | $T_C = 25 ^{\circ}\text{C}$ $T_C = 100 ^{\circ}\text{C}$ | I _D | 9 | | |
| | V _{GS} at 10 V | T _C = 100 °C | | 7.3 | Α | |
| Pulsed Drain Current ^a | | | I _{DM} | 28 | í | |
| Linear Derating Factor | | | | 1.89 | W/°C | |
| Single Pulse Avalanche Energy b | | | E _{AS} | 86 | mJ | |
| Maximum Power Dissipation | | | P_{D} | 109 | W | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to +150 | °C | | |
| Drain-Source Voltage Slope | T _J = 125 °C | | dV/dt | 50 | V/ns | |
| verse Diode dV/dt ^d | | av/at | 3.2 | V/IIS | | |
| Soldering Recommendations (Peak Temperature) ^c | for 10 s | | | 300 | °C | |

- a. Repetitive rating; pulse width limited by maximum junction temperature. b. $V_{DD}=50$ V, starting $T_J=25$ °C, L=28.2 mH, $R_g=25$ Ω , $I_{AS}=3.5$ A.

- c. 1.6 mm from case. d. $I_{SD} \le I_D$, dl/dt = 100 A/ μ s, starting $T_J = 25$ °C.



| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------------|-------------------|---|-----|------|--|
| PARAMETER | SYMBOL TYP. MAX. | | | UNIT | |
| Maximum Junction-to-Ambient | R _{thJA} | - | 72 | °C/W | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 0.7 | G/VV | |

| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|--|----------------------|------|------|-------|------|
| Static | | <u> </u> | | | | | • |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 900 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference to 25 °C, I _D = 1 mA | | - | 0.65 | - | V/°C |
| Gate-Source Threshold Voltage (N) | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ | | 2 | - | 4 | V |
| | I _{GSS} | V _{GS} = ± 20 V | | - | - | ± 100 | nA |
| Gate-Source Leakage | | V _{GS} = ± 30 V | | - | - | ± 1 | μA |
| | | V _{DS} = 900 V, V _{GS} = 0 V V _{DS} =620 V, V _{GS} = 0 V, T _J = 125 °C | | - | - | 1 | μΑ |
| Zero Gate Voltage Drain Current | I_{DSS} | | | - | - | 10 | |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 6 A | - | 0.75 | - | Ω |
| Forward Transconductance | 9 _{fs} | V _{DS} = 30 V, I _D = 6 A | | - | 19 | - | S |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | $V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1 MHz | | _ | 373 | T - | pF |
| Output Capacitance | C _{oss} | | | - | 26 | - | |
| Reverse Transfer Capacitance | C _{rss} | | | - | 14 | - | |
| Effective Output Capacitance, Energy Related ^a | C _{o(er)} | V _{DS} = 0 V to 520 V, V _{GS} = 0 V | | - | 46 | - | |
| Effective Output Capacitance, Time Related ^b | C _{o(tr)} | | | - | 64 | - | |
| Total Gate Charge | Qg | | | - | 26 | | |
| Gate-Source Charge | Q _{gs} | $V_{GS} = 10 \text{ V}$ $I_D = 6 \text{ A}, V_{DS} = 520 \text{ V}$ | | - | 2.1 | - | nC |
| Gate-Drain Charge | Q _{gd} | 1 | | - | 2.8 | - | 1 |
| Turn-On Delay Time | t _{d(on)} | $V_{DD} = 620 \text{ V}, I_D = 6 \text{ A}, V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$ | | - | 26 | - | ns |
| Rise Time | t _r | | | - | 55.7 | - | |
| Turn-Off Delay Time | t _{d(off)} | | | - | 71 | - | |
| Fall Time | t _f | | | - | 41 | - | |
| Gate Input Resistance | R_g | f = 1 MHz, open drain | | - | 3.5 | - | Ω |
| Drain-Source Body Diode Characteristic | S | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 7 | |
| Pulsed Diode Forward Current | I _{SM} | | | - | - | 18 | A |
| Diode Forward Voltage | V _{SD} | T _J = 25 °C, I _S = 6 A, V _{GS} = 0 V | | - | - | 1.4 | V |
| Reverse Recovery Time | t _{rr} | T _J = 25 °C, I _F = I _S = 6 A, dl/dt = 100 A/µs, V _R = 400 V | | - | 192 | - | ns |
| Reverse Recovery Charge | Q _{rr} | | | _ | 2.4 | - | μC |
| Reverse Recovery Current | I _{RRM} | | | _ | 11 | | A |

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

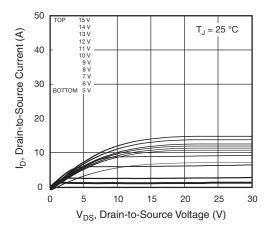


Fig. 1 - Typical Output Characteristics

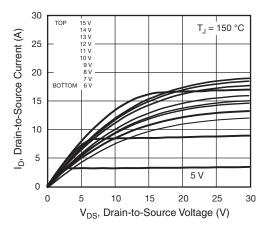


Fig. 2 - Typical Output Characteristics

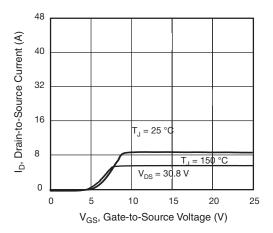


Fig. 3 - Typical Transfer Characteristics

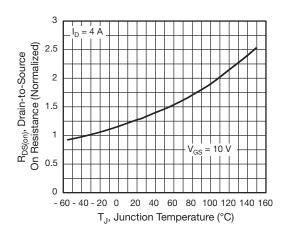


Fig. 4 - Normalized On-Resistance vs. Temperature

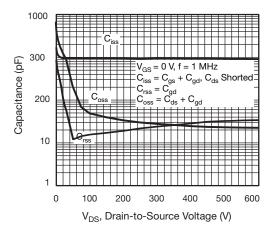


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

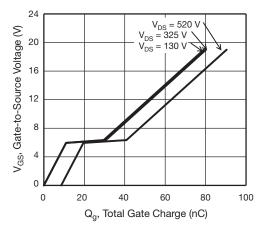


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



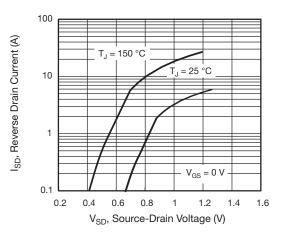


Fig. 7 - Typical Source-Drain Diode Forward Voltage

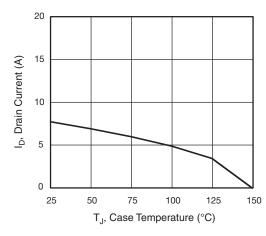


Fig. 9 - Maximum Drain Current vs. Case Temperature

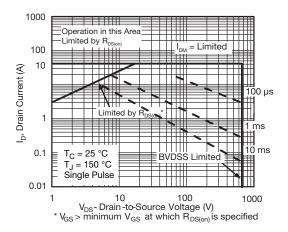


Fig. 8 - Maximum Safe Operating Area

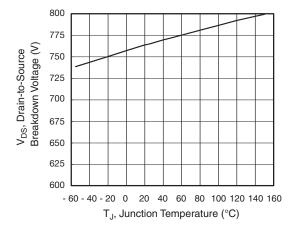


Fig. 10 - Temperature vs. Drain-to-Source Voltage

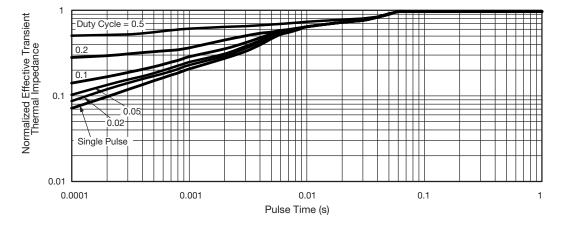


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



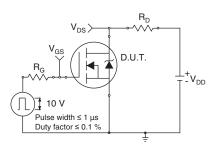


Fig. 12 - Switching Time Test Circuit

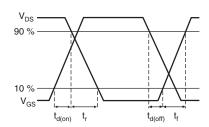


Fig. 13 - Switching Time Waveforms

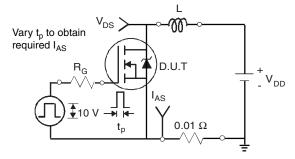


Fig. 14 - Unclamped Inductive Test Circuit

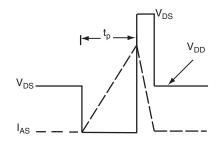


Fig. 15 - Unclamped Inductive Waveforms

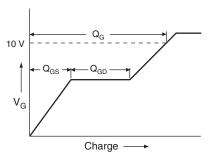


Fig. 16 - Basic Gate Charge Waveform

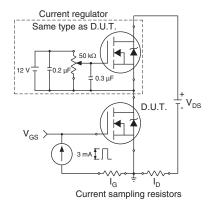
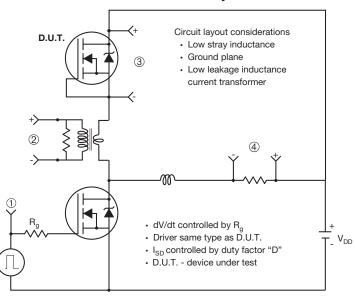


Fig. 17 - Gate Charge Test Circuit

6



Peak Diode Recovery dV/dt Test Circuit



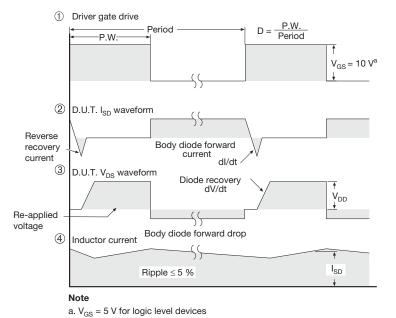


Fig. 18 - For N-Channel



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